November 2016



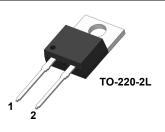
ON Semiconductor® FFSP08120A Silicon Carbide Schottky Diode 1200 V, 8 A

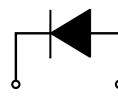
Features

- Max Junction Temperature 175 °C
- Avalanche Rated 80 mJ
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery / No Forward Recovery

Applications

- General Purpose
- SMPS, Solar Inverter, UPS
- Power Switching Circuits





1. Cathode 2. Anode

1. Cathode

Description

2. Anode

Silicon Carbide (SiC) Schottky Diodes use a completely new

technology that provides superior switching performance and

higher reliability compared to Silicon. No reverse recovery

current, temperature independent switching characteristics, and excellent thermal performance sets Silicon Carbide as the next

generation of power semiconductor. System benefits include

highest efficiency, faster operating frequency, increased power density, reduced EMI, and reduced system size & cost.

Absolute Maximum Ratings T_C = 25 °C unless otherwise noted.

Symbol	Paramete	FFSP08120A	Unit	
V _{RRM}	Peak Repetitive Reverse Voltage	1200	V	
E _{AS}	Single Pulse Avalanche Energy	80	mJ	
l _F	Continuous Rectified Forward Current @ Tc < 148 °C		8	А
I _{F, Max}	Non-Repetitive Peak Forward Surge Cur- rent	T _C = 25 °C, 10 μs	530	Α
		T _C = 150 °C, 10 μs	480	Α
I _{F,SM}	Non-Repetitive Forward Surge Current Half-Sine Pulse, t _p = 8.3 ms		68	Α
I _{F,RM}	Repetitive Forward Surge Current	Half-Sine Pulse, t _p = 8.3 ms	32	А
Ptot	Dewer Dissignation	T _C = 25 °C	166	W
	Power Dissipation	T _C = 150 °C	27	W
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +175	°C	

Thermal Characteristic

Symbol	Parameter	FFSP08120A	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max	0.9	°C/W

		Package	PackagePacking MethodReeTO-220-2LTubeN		Tape Width	Quantity 50 units		
		TO-220-2			N/A			
ectrica	al Chara	acteristics T _c =	25 °C unless	otherwise noted.				
Symbol		Parameter		Test Conditions	Mir	п. Тур.	Max.	Unit
V _F			I	I _F = 8 A, T _C = 25 ^o C	-	1.45	1.75	
	Forward Voltage		l _F = 8 A, T _C = 125 ^o C	-	1.7	2	V	
			1	l _F = 8 A, T _C = 175 ^o C	-	2	2.4	
R			١	V _R = 1200 V, T _C = 25 °C	-	-	200	
	Reverse Current		V _R = 1200 V, T _C = 125 ^o C	-	-	300	μA	
			١	V _R = 1200 V, T _C = 175 ^o C	-	-	400	
с	Total Capacitive Charge		V = 800 V	-	55	-	nC	
C			١	V _R = 1 V, f = 100 kHz	-	538	-	
	Total Capacitance		V _R = 400 V, f = 100 kHz	-	50	-	pF	
	1		N	V _R = 800 V, f = 100 kHz	-	40	-	1

Notes: 1: EAS of 80 mJ is based on starting T_J = 25 °C, L = 0.5 mH, I_{AS} = 18 A, V = 150 V.

Typical Characteristics $T_J = 25$ °C unless otherwise noted.

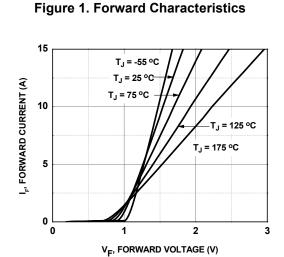


Figure 3. Reverse Characteristics

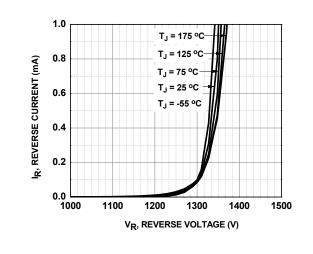
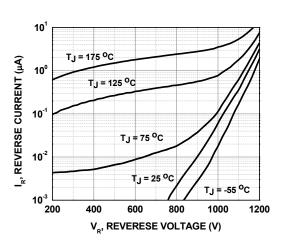
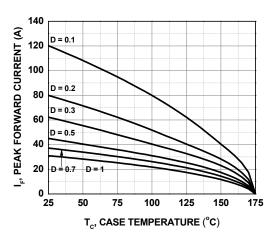
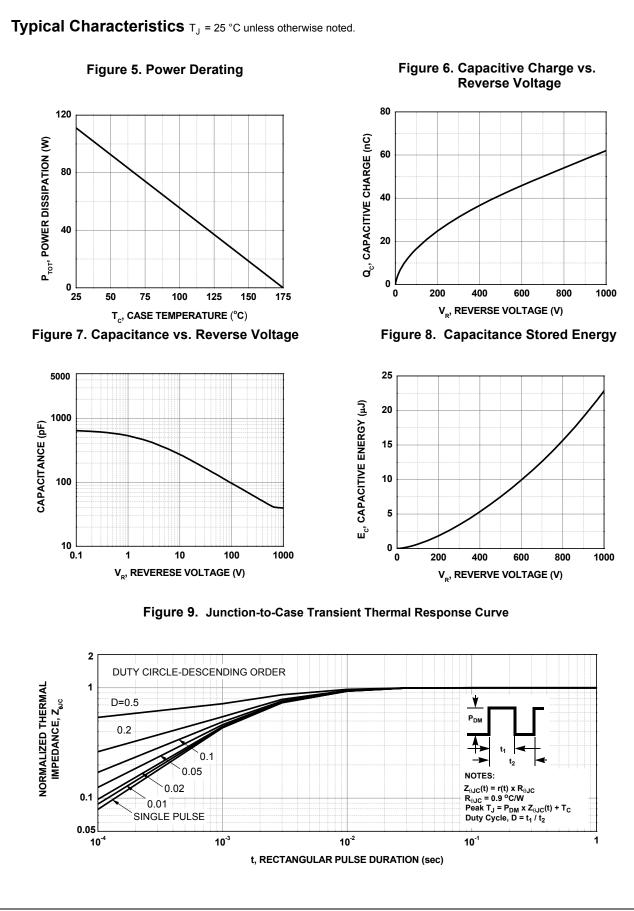


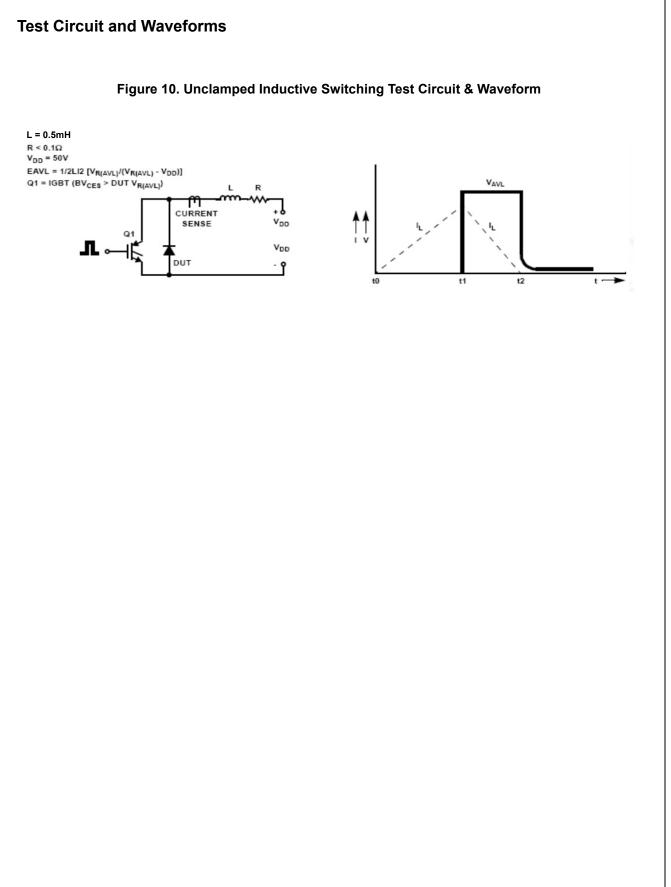
Figure 2. Reverse Characteristics











Ø 4.09 3.50 ⊕ 0.36 M B A M 10.67 В Α 9.65 8.89 3.43 1.40 6.86 2.54 0.51 6.86 **7**° 5.84 3° T 13.40 16.51 12,19 14,22 16.15 9.40 15,75 8.38 **5**° **5**° 3° 3° 6.35 MAX 2 1 0.60 MAX С 14.73 13,60 1.65 (1.91)1.25 F Т 0.61 2.54 0.33 1.02 2.92 0.38 2.03 5.08 ⊕ 0.36 M C A B **5° 5°** 3° 3° -...... FAIRCHILD ... 4.80 4.30

NOTES:

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